

Application Serial No: 10/790,339
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Amendments to the Specification:

Please replace paragraph [0023] on page 4 with the following rewritten paragraph:

--[0023] ~~FIG. 10 shows~~ FIGS. 10a-b show an embodiment of the present invention where the dielectric layer is enclosed with conductive polysilicon; and--

Please replace paragraph [0023] on page 4 with the following rewritten paragraph:

--[0041] Alternatively, a conductive layer is deposited before the dielectric layer 50 is deposited so that the cantilever 20 is completely enclosed by conductive polysilicon. ~~FIG. 10 shows~~ FIGS. 10a-b show a cross sectional view of a cantilever completely enclosed by polysilicon.--